

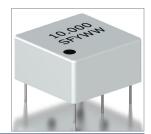
## Metal DIP CMOS OCXO SOC50S Series 50.0mm x 50.0mm

## **Features**

- ±5.0ppb (Frequency Stability) Available
- Sinewave
- OCXO
- AT-Cut or SC-Cut

## Applications

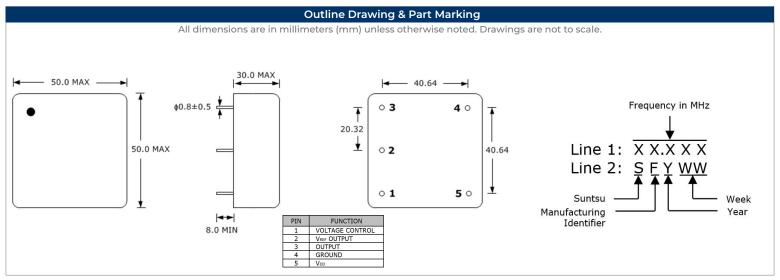
- Military Communication Equipment
- Base Stations
- Test Equipment
- Synthesizers
- Digital Switching

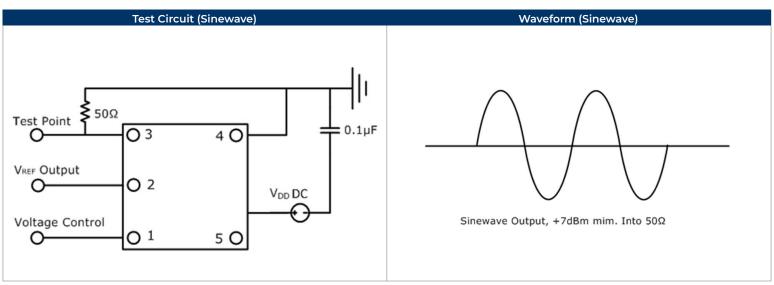


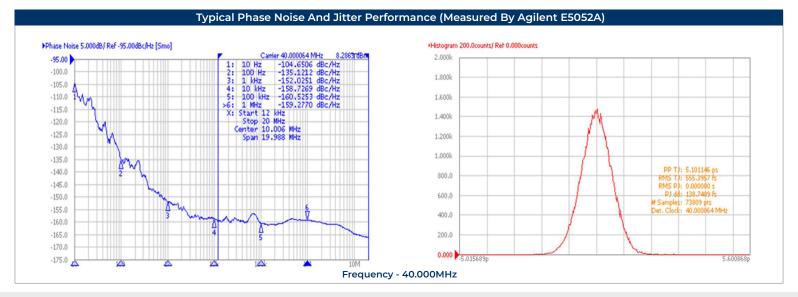
**Part Numbering Guide** SOC 50 S 12 K 47 A - 10.000M SUNTSU OCXO **FREQUENCY** Type Of 50.0mm x 50.0mm -Crystal SINEWAVE -**OPERATING** A: AT-Cut B:SC-Cut TEMPERATURE RANGE 05:0°C-+50°C SUPPLY VOLTAGE FREQUENCY STABILITY 15 : -10°C - +55°C 05:5.0V±5% F: ±500ppb 09:9.0V±5% 2:-20°C-+60°C I: ±200ppb 12:12.0V±5% 37:-30°C-+70°C J: ±100ppb 47:-40°C-+70°C K: ±50ppb L:±20ppb M:±10ppb Cage Code: 4GUT4 N: ±7.5ppb O: ±5.0ppb To customize your parameters contact a Suntsu representative.

Electrical Parameters	Units	Minimum	Typical	Maximum	Remarks
Frequency Range	MHz	5		100	
Frequency Tolerance at +25°C	ppb	-100		+100	
Freq. Stability vs. Op Temp.	ppb	-10		+10	See part numbering guide for options.
Freq. Stability vs. Supply Voltage	ppb	-5		+5	V <sub>DD</sub> ±5% Change
Freq. Stability vs. Load	ppb	-5		+5	±10% Change
Freq. Stability vs. Aging/Year	ppb	±50		±300	AT-Cut : ±300/Year, SC-Cut : ±50/Year
Operating Temperature	°C	-40		+70	See part numbering guide for options.
Storage Temperature	°C	-45		+85	
Supply Voltage (VDD)	V	VDD-5%	VDD	V <sub>DD</sub> +5%	See part numbering guide for options.
Power Consumption At Turn On	W			6.0	
Power Consumption At 25°C	W			2.0	
Control Voltage (Vc)	V	0.0		5.0	
Control Middle Voltage	V		2.5		
Pullability (AT-Cut)	ppm	±2.0			AT-Cut
Pullability (SC-Cut)	ppm	±0.5			SC-Cut
Linearity	%			10	
Vc Input Impedance	ΚΩ	50			
Deviation Slope			Positive		
Output Logic (Sinewave) Load	Ω			50	
Output Logic Waveform	dBm	7			
Output Logic Spurious (Harmonic)	dBc			-30	
Output Logic Spurious (Non-Harmonic)	dBc			-70	
Reference Voltage Output (V <sub>ref</sub> )	V			5	
Symmetry (Duty Cycle)	%	45	50	55	
Start-UP Time	ms			3	
Warm-Up Time	ppb	-50		50	At 25°C After 5Mins.













<b>Environmental Specificat</b>	ions	Mechanical Specifications		
Temperature Cycling	MIL-STD-883, Method 1010, Condition B	Mechanical Shock	MIL-STD-202, Method 213, Condition B	
Lead Integrity	MIL-STD-883, Method 1014, Condition A	Vibration	MIL-STD-883, Method 2007, Condition A	
Gross Leak Test	MIL-STD-883, Method 1014, Condition C	Resistance to Soldering Heat	MIL-STD-202, Method 210, Condition A	
Solderability	MIL-STD-883, Method 2003	Resistance to Solvents	MIL-STD-202, Method 215	